

PCN Number:	20170918000	PCN Date:	September 22, 2017
Title:	Datasheet for SN74AUP1G14		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
		<input type="checkbox"/>	Wafer Bump Site
		<input type="checkbox"/>	Wafer Bump Material
		<input type="checkbox"/>	Wafer Bump Process
		<input type="checkbox"/>	Wafer Fab Site
		<input type="checkbox"/>	Wafer Fab Materials
		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



SN74AUP1G14

SCES578J – JUNE 2003 – REVISED SEPTEMBER 2017

Changes from Revision I (May 2010) to Revision J

Page

• Added DPW (X2SON) package, preview only	1
• Added <i>Device Information</i> table, <i>Pin Configuration and Functions</i> section, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section.	1
• Deleted <i>Ordering Information</i> table, see <i>Mechanical, Packaging, and Orderable Information</i> section at the end of the data sheet	1
• Changed formatting of YFP package pinout drawing	3
• Deleted YZP package from data sheet	3
• Added Junction temperature, T_J in <i>Absolute Maximum Ratings</i>	4

The datasheet number will be changing.

Device Family	Change From:	Change To:
SN74AUP1G14	SCES578H	SCES578J

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/SN74AUP1G14>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

PSN74AUP1G14DPWR	SN74AUP1G14DBVR	SN74AUP1G14DBVRG4	SN74AUP1G14DBVT
SN74AUP1G14DCKR	SN74AUP1G14DCKRE4	SN74AUP1G14DCKRG4	SN74AUP1G14DCKT
SN74AUP1G14DRLR	SN74AUP1G14DRYR	SN74AUP1G14DSFR	SN74AUP1G14YFPR

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com